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NOTIFICATION OF REASONS FOR REJECTION

Patent Application No.: Patent Application No. 064260 of Heisei 11 [1999]
Draft Date: July 9, 2002
Patent Office Examiner: Sadatsugu Tanaka 4231 5R00
Agent of Patent Applicant: Takekazu Morishita
Applicable Sections: Section 29 (2)

[Stamp: Received, 7/17/02, Morishita Patent Office]

The present application should be rejected for the following reasons. If you have an opinion concerning this, please submit a statement of opinion within 60 days of the date of dispatch of this notification.

Reasons

The inventions claimed in the following claims of the present application are inventions that could easily have been invented prior to the filing of the application by a person having an ordinary knowledge of the technical field to which the inventions belong on the basis of inventions described in the following publications, which were disseminated in Japan or in foreign countries prior to the filing of the application. Thus, in accordance with the provisions of Section 29 (2) of the Patent Law, these inventions cannot be patented.

Note (For cited references, etc., see the Table of Cited References, etc.)

- Claim 1
- Cited References, etc. 1
- Remarks

A technique of burning [molded bodies] in a state in which powder is interposed between the surfaces thereof is described in Cited Reference 1. It is recognized that the use of said technique in the burning of a magnetic material core is not particularly [difficult] for a person skilled in the art.

- Claims 2 and 3
- Cited References, etc. 1 and 2
- Remarks

It is recognized that deciding the particle diameters of the powder to be 1000 μm or less regardless of whether the powder is an organic material or inorganic material is not particularly [difficult].

In regard to the inventions claimed in claims other than the claims indicated in this Notification of Reasons for Rejection, no reasons for rejection have been discovered at this time. If reasons for rejection are newly discovered, you will be notified of these reasons for rejection.

[Stamp: —, 7/22/02, Hayashi]

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Table of Cited References, etc.

1. Japanese Patent Application Kokai No. H03-145101
 2. Japanese Patent Application Kokai No. H03-199168
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Record of Results of Survey of Prior Art References

- Field surveyed: IPC 7th Edition H 01 F 41/02
- Prior Art References:

This record of the results of a survey of prior art references does not constitute any reason for rejection.